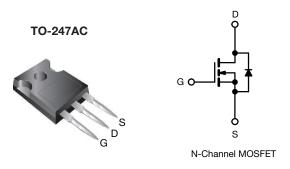
# SiHG039N60E

**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.034			
Q <sub>g</sub> max. (nC)	126				
Q <sub>gs</sub> (nC)	29				
Q <sub>gd</sub> (nC)	28				
Configuration	Single				

## **FEATURES**

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
    - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and halogen-free	SiHG039N60E-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V <sub>DS</sub>	600	N/		
Gate-source voltage			V <sub>GS</sub>	± 30	V		
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub> -	63			
	VGS at 10 V	T <sub>C</sub> = 100 °C		40	А		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	199			
Linear derating factor				2.9	W/°C		
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	633	mJ		
Maximum power dissipation			PD	357	W		
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	T <sub>J</sub> = 125 °C		alı . /alt	70	\//mm		
Reverse diode dv/dt <sup>d</sup>		dv/dt	6.3	V/ns			
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			260	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 6.7 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C





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PARAMETER	SYMBOL	TYP.		ΜΔΧ				
	_			MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 40			°C/W			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.35						
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDITION	IS	MIN.	TYP.	MAX.	UNI
Static		•			•	•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250	μA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> =	= 1 mA	-	0.65	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA		3	-	5	V
		$V_{GS} = \pm 20 V$			-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA	
		V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub>	= 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 32 A		-	0.034	0.039	Ω
Forward transconductance	9 <sub>fs</sub>	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 32 \text{ A}$		-	17	-	S	
Dynamic								
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	4369	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 100 V,$ f = 1 MHz $V_{DS} = 0 V to 480 V, V_{GS} = 0 V$		-	178	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	7	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	143	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	870	-		
Total gate charge	Qg				-	84	126	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 32 \text{ A}, V_{DS} = 480 \text{ V}$		-	29	-	nC	
Gate-drain charge	Q <sub>gd</sub>			-	28	-		
Turn-on delay time	t <sub>d(on)</sub>				-	79	119	
Rise time	t <sub>r</sub>	$V_{DD}$ = 480 V, I_D = 32 A, $V_{GS}$ = 10 V, R_g = 24 $\Omega$		: A,	-	126	190	1
Turn-off delay time	t <sub>d(off)</sub>			-	176	264	ns	
Fall time	t <sub>f</sub>			-	94	141		
Gate input resistance	Rg	f = 1 MHz, open drain			0.3	0.7	1.4	Ω
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50	•	
Pulsed diode forward current	I <sub>SM</sub>			-	-	155	A	
			T <sub>J</sub> = 25 °C, I <sub>S</sub> = 32 A, V <sub>GS</sub> = 0 V					
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 32 A, V <sub>G</sub>	<sub>is</sub> = 0 V	-	-	1.2	V

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

Q<sub>rr</sub>

 $I_{\text{RRM}}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

Reverse recovery charge

Reverse recovery current

2

 $\begin{array}{l} T_J=25~^\circ C,~I_F=I_S=32~A,\\ di/dt=100~A/\mu s,~V_R=25~V \end{array}$ 

24.2

-

μC

А

12.1

30

-

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

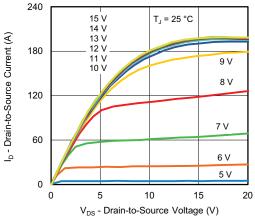


Fig. 1 - Typical Output Characteristics

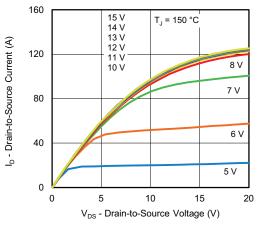


Fig. 2 - Typical Output Characteristics

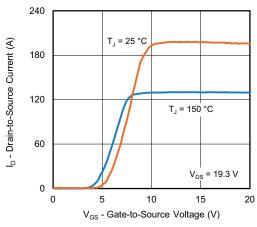


Fig. 3 - Typical Transfer Characteristics

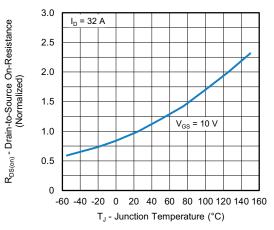


Fig. 4 - Normalized On-Resistance vs. Temperature

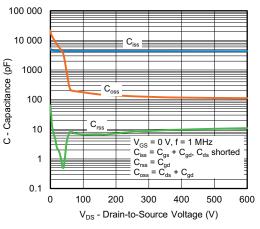
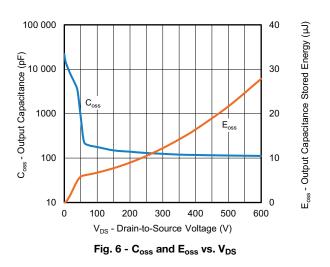


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S18-0972-Rev. A, 01-Oct-2018

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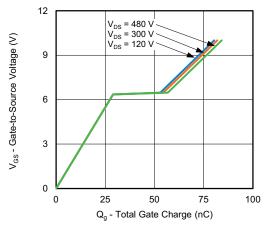


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

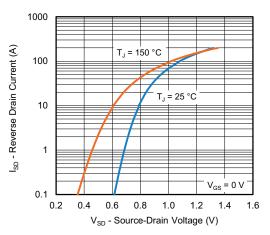


Fig. 8 - Typical Source-Drain Diode Forward Voltage

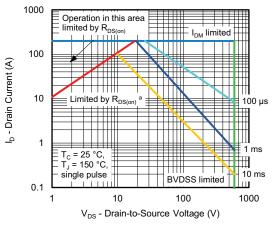


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

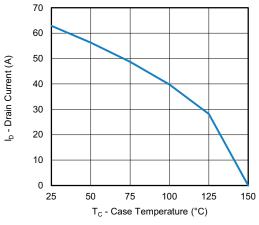


Fig. 10 - Maximum Drain Current vs. Case Temperature

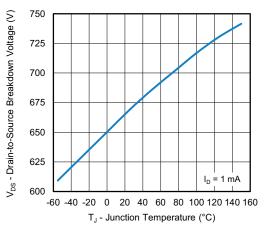
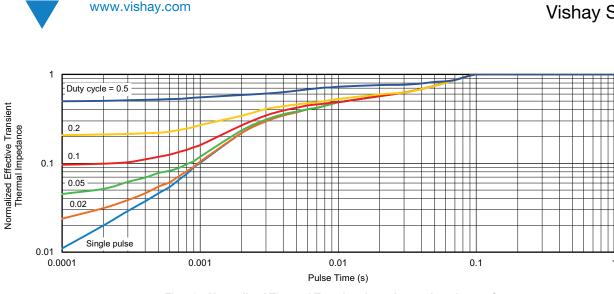


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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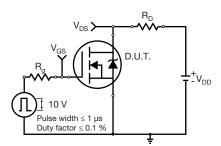


Fig. 13 - Switching Time Test Circuit

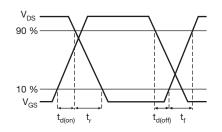


Fig. 14 - Switching Time Waveforms

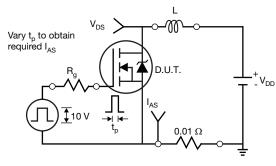


Fig. 15 - Unclamped Inductive Test Circuit

V<sub>DD</sub> VDS AS

Fig. 16 - Unclamped Inductive Waveforms

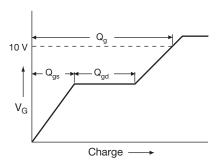


Fig. 17 - Basic Gate Charge Waveform

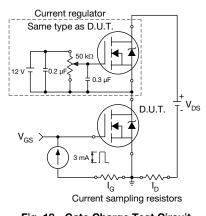


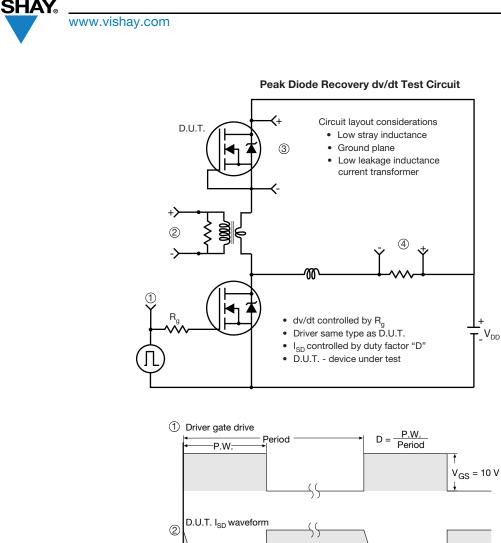
Fig. 18 - Gate Charge Test Circuit

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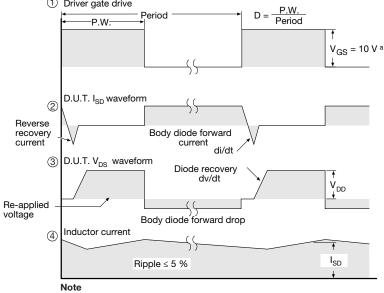
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a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

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